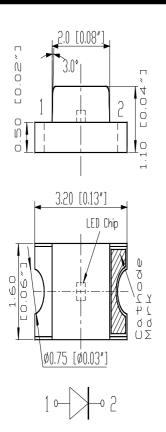
表面黏著型發光二極體指示燈

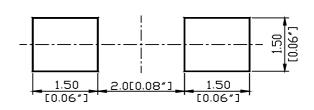
S150 Series SMD Chip LED Lamps

Part Number: Q1500VS4

Package outlines









| ITEM | MATERIALS |
|-----------------------|-------------------|
| Resin (mold) | Ероху |
| Bonding Wire | Ø 25 μm Au |
| Lens color | Water transparent |
| Printed circuit board | BT (white) |
| Dice | AlGaInP |
| Emitted color | Red |

NOTES:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.

表面黏著型發光二極體指示燈

Forward voltage

Luminous intensity

| Part Number: Q1500VS4 | | | | | | |
|---|---------------|---------------|---------|------------------------|--------------|------|
| Absolute maximum ratings (T _A =25°C) | | | | | | |
| Parameter | Symbol | | Value | | | Unit |
| Forward current | If | | 30 | | | mA |
| Reverse voltage | Vr | | 5 | | | V |
| Power dissipation | Pd 81 | | | mW | | |
| Operating temperature range | Top -20 ~+80 | | 0 | $^{\circ}\!\mathbb{C}$ | | |
| Storage temperature range | Tstg | Tstg -20 ~+80 | | 0 | $^{\circ}$ C | |
| Peak pulsing current (1/8 duty | lfp | Ifp | | 125 | | mA |
| f=1kHz) | | | | | | |
| Electro-optical character | istics | | | $(T_A=2$ | 25°C) | |
| Parameter | Test | Symbo | Value υ | | Unit | |
| | Conditio n | l | Min | Тур | Max | |
| Wavelength at peak emission | If=20mA | λpeak | 630 | 635 | 640 | nm |
| Spectral half bandwidth | If=20mA | Δλ | | 20 | | nm |
| Dominant wavelength | If=20mA | λdom | 619 | 624 | 629 | nm |

If=20mA

If=20mA

*1

Vf

Ιv

2.20

600

2.70

mcd

| Viewing angle at 50% Iv | lf=10mA | 201/2 | 140 | | Deg |
|-------------------------|---------|-------|---------|----|-----|
| Reverse current | Vr=5V | lr | | 10 | μΑ |

 ± 1 Note: Luminous intensity tolerances are $\pm 10^{\scriptscriptstyle \square}$.

URFACE MOUNT LED LAMPS

表面黏著型發光二極體指示燈

Part Number: Q1500VS4

OPTICAL CHARACTERISTIC CURVES Relative Intensity vs. Wavelength 100 80 60 40 20 400 700 1000 300 500 900 1100 Wavelength (nm) Forward Current vs. Forward Voltage (V) 2.650 2.500 Forward Voltage (V) 2.000 1.500 1,000 0.500 0.000-Forward Current (mA) **Directive Characteristics** 0* -30° 30° -60° 60°

0

50%

100%

SURFACE MOUNT LED LAMPS

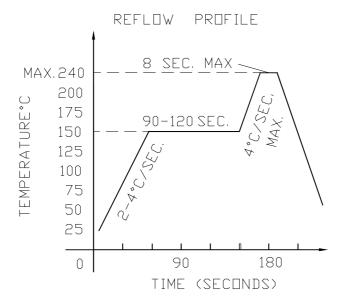
100%

50%

表面黏著型發光二極體指示燈

Reflow Profile

■ Reflow Temp/Time

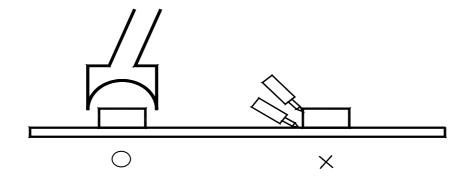


■Soldering iron

Basic spec is \leq 5sec when 260°C. If temperature is higher, time should be shorter

(+10°C \rightarrow -1sec).Power dissipation of iron should be smaller than 15W, and temperatures should be controllable .Surface temperature of the device \blacksquare Rework

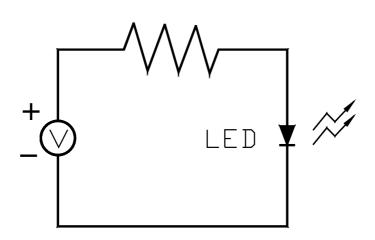
- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



表面黏著型發光二極體指示燈

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause

big current change (Burn out will happen).

2.Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature : 5° C ~ 30° C (41° F ~ 86° F)

2.2 Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <30% R.H. after the package is

Opened, the products should be used within a week or they should be keeping to stored at

 \leq 20 R.H. with zip-lock sealed.

3.Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The

Conditions are as followings:

- 3.1 60 ± 3 °C x(12~24hrs) and <5%RH, taped reel type
- 3.2 $100\pm3^{\circ}$ C x(45min~1hr), bulk type
- 3.3 $130\pm3^{\circ}$ C x(15~30min), bulk type

When you discover that the desiccant in the package has a pink color (normal=blue), you

Should treat them in the same conditions as (3.1-3.3)

表面黏著型發光二極體指示燈

| Test items and results of reliability | | | | | | |
|---------------------------------------|---------------------------------|---|-----------|----------------------|--|--|
| Туре | Test Item | Test Conditions | Note | Number of Damaged | | |
| Sequement | Temperature Cycle | -20°C 30min ↑↓ 80°C 30min | 100 cycle | 0/22 | | |
| | Thermal Shock | -20°C 15min ↑↓ 80°C 15min | 100 cycle | 0/22 | | |
| | High Humidity Heat Cycle | 30°C⇔ 65°C 90%RH 24hrs/1cycle | 10 cycle | 0/22 | | |
| | High Temperature Storage | T _a =80°C | 1000 hrs | 0/22 | | |
| | Humidity Heat Storage | T _a =60°C RH=90% | 1000 hrs | 0/22 | | |
| ion | Low Temperature Storage | T _a =-30°C | 1000 hrs | 0/22 | | |
| Se Opena tion | Life Test | T_a =25 $^{\circ}$ C I_F =20mA | 1000 hrs | 0/22 | | |
| | High Humidity Heat Life Test | 60°C RH=90% I _F =20mA | 500 hrs | 0/22 | | |
| | Low Temperature Life Test | T _a =-20°C I _F =20mA | 1000 hrs | 0/22 | | |